300

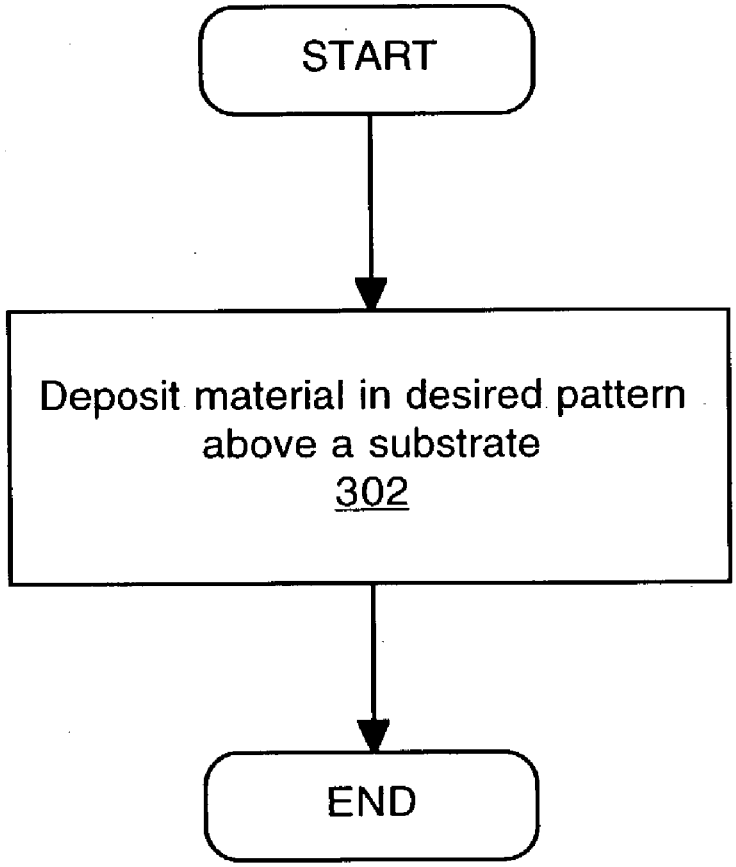
START
Deposit material in desired pattern above a substrate
302
END

Fig. 3